

1st International Conference On Embedded Systems And Artificial Intelligence

ESAI'19

May 02-03, 2019, Fez - Morocco

<http://www.esai19.com>

Call For Papers

LIST OF TOPICS

COMPUTER SCIENCE, ARTIFICIAL INTELLIGENCE AND INFORMATION TECHNOLOGIES :

- Engineering and Computational Intelligence
- Business Intelligence and Big Data
- Data Mining, Knowledge Representation, Discovery and Management
- Business Intelligence and Big Data
- Smart Wireless Sensors and Systems
- Security, Smart grids and Wireless network technologies
- E-Learning, Massive Open Online Courses (MOOC), Educational Technology and Serious Games
- Mobile, Cloud Computing and Virtualization
- Image, Video and Speech Processing
- Bioinformatics , Source separation
- Bayesian learning and signal processing
- Hardware Engineering and Independent component analysis
- Agents , Multi-Agent Systems, Fuzzy and Expert systems
- Neural Networks and Computational neuroscience
- Connectionist theory and cognitive science
- Machine and Deep learning
- Supervised, unsupervised, and reinforcement learning
- Brain imaging and neural information processing
- Evolutionary algorithms and Automatic speech recognition
- Audio-visual speech recognition
- Speech and signal processing
- Speaker recognition, Speech analysis
- Natural language processing (NLP)

EMBEDDED SYSTEMS, , MECHATRONIC AND APPLICATIONS :

- Stand alone embedded systems
- Real time embedded systems
- Networked embedded systems
- Mobile embedded systems
- Embedded Systems in Automobiles and in telecommunications
- Embedded Systems in Smart Cards, Missiles and Satellites
- Embedded Systems in Peripherals and Computer Networking
- Embedded Systems in Consumer Electronics
- Mechanics of materials and structures
- Damage and rupture
- Control
- Mechatronics
- Signal and Systems
- Modeling and Automation

RENEWABLE ENERGY :

- Efficient Energy Management in Buildings
- Solar Energy Systems
- Renewable Energy Sources and System Integration
- Emergent Renewables and Smart Grids
- Wind Energy Systems
- Efficiency and Policies

CIRCUITS, SUBSYSTEMS AND PASSIVE COMPONENTS:

- Metallic materials
- Metamaterials
- Planar Filters
- Planar Passive Components and Circuits
- Emerging Technology
- RF MEMS
- Non-Planar Passive Components and Circuits

CONFERENCE CHAIR

Hassan SATORI, FSDM Fez, Morocco

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IMPORTANT DATES

PAPERS SUBMISSION DEADLINE

January 15th, 2019

ACCEPTANCE NOTIFICATION

February 15th, 2019

CAMERA READY

Mars 15th, 2019

REGISTRATION DEADLINE

Mars 30th, 2019

CONTACT DETAILS

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WEBSITE

<http://www.esai19.com>

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